









PRODUCT DATASHEET



- ► PLCC2 SMD
- ► 4014 0.65t
- ► Cool White 6500K

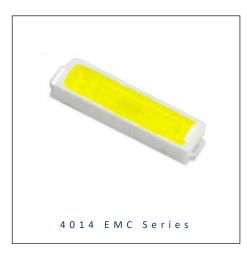
N0W64S17











APPLICATIONS:

- General Lighting
- Portable Lighting
- Commercial Lighting
- Indoor Lighting
- Backlight for LCD

FEATURES:

- Package: Top View PLCC2 White Package
- Forward Current: 60mA
- Forward Voltage (typ.): 2.8V
- Luminous Flux (typ.): 27lm@60mA
- Colour: Cool White
- Colour Temperature (CCT): 6500K
- Viewing angle: 120°
- Materials:
 - Die: InGaN
 - Resin: Silicon (Yellow Diffused)
 - Package: PLCC
- Operating Temperature: -40~+85°C
- Storage Temperature: -40~+85°C
- Electrostatics Discharge: 1000V
- Grouping parameters:
 - Forward Voltage
 - Luminous Flux
 - CIE Chromaticity
- Soldering methods: Reflow Soldering
- MSL Level: MSL3 according to J-STD020
- Packing: 12mm tape with max.4000/reel, ø178mm (7")



CHARACTERISTICS:

Absolute Maximum Characteristics (Ta=25°C)

Parameter	Symbol	Ratings	Unit
DC Forward Current	I _F	90	mA
Pulse Forward Current (Duty 1/10, width≤100μS)	IPF	120	mA
Power Dissipation	P _D	270	mW
Reverse Voltage	V _R	5	V
Reverse Current @10V	I _R	10	μΑ
Junction Temperature	Tj	105	°C
Electrostatic Discharge	ESD	1000	V
Thermal Resistance (Junction to Solder Point)	R _{THJS}	16	°C/W
Operating Temperature	T _{OPR}	-40~+85	°C
Storage Temperature	T _{STG}	-40~+85	°C
Soldering Temperature	T _{SOL}	245 for 10S	°C
Colour Rendering Index	CRI	90	

Electrical & Optical Characteristics (Ta=25°C, RH=60%)

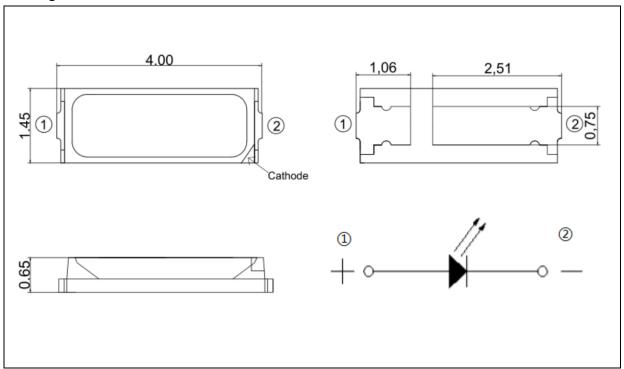
Parameter	Symbol Values				Unit		
Parameter	Зуппоп	Min.	Min. Typ.		Offic	Condition	
Forward Voltage	V _F	2.6	2.8	3.0	V	I _F =60mA	
Luminous Flux	Ф۷	24	27	30	lm	I _F =60mA	
Chromaticity Coordinates	Х		0.3130			I _F =60mA	
	Υ		0.3290				
Colour Temperature	ССТ		6500		К	I _F =60mA	
Viewing Angle	2θ _{1/2}		120		deg	I _F =60mA	

^{1.} Luminous flux (Φ_V) ±10%, Forward Voltage (V_F) ±0.1V, CRI ±2



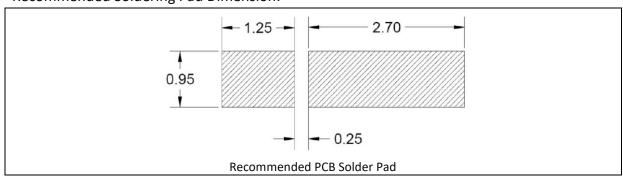
OUTLINE DIMENSION:

Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.2mm, unless otherwise noted.

Recommended Soldering Pad Dimension:



- 1. Dimensions are in millimetre (mm).
- 2. Tolerance ±0.1mm with angle tolerance ±0.5°.



BINNING GROUPS:

Forward Voltage Classifications (I_F = 60mA):

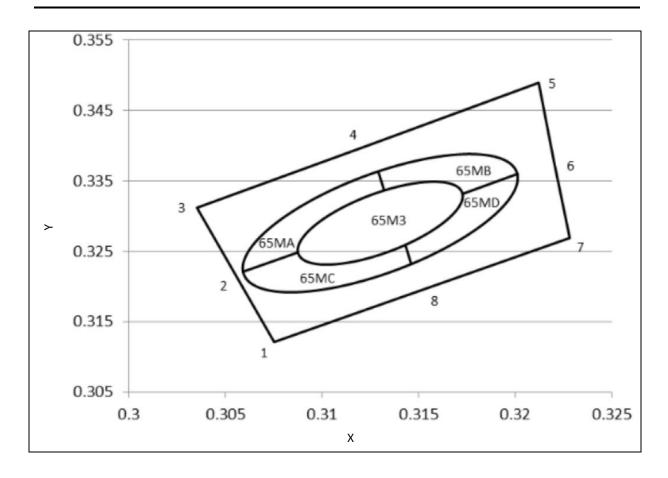
Code	Min.	Max.	Unit
Z1	2.6	2.7	
A1	2.7	2.8	V
B1	2.8	2.9	V
C1	2.9	3.0	

Luminous Flux Classifications ($I_F = 60 \text{mA}$):

Code	Min.	Max.	Unit
D5	24	26	
D6	26	28	lm
D7	28	30	



CIE CHROMATICITY DIAGRAM:



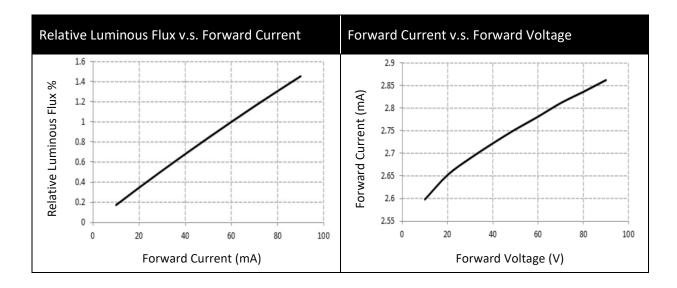
Chromaticity Coordinates Classifications (I_F = 60mA):

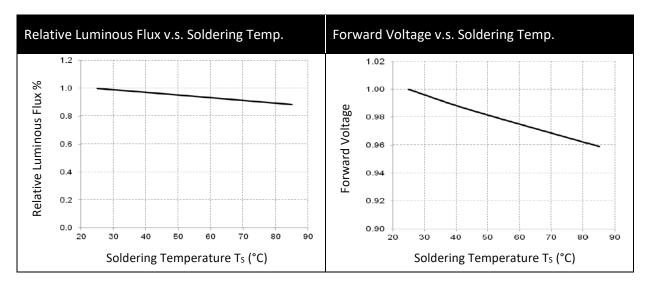
	Code	Centre		Radius		Angle
a /		Х	Υ	а	b	Φ
D D	65M5	0.3130	0.3290	0.002230	0.000950	58.34

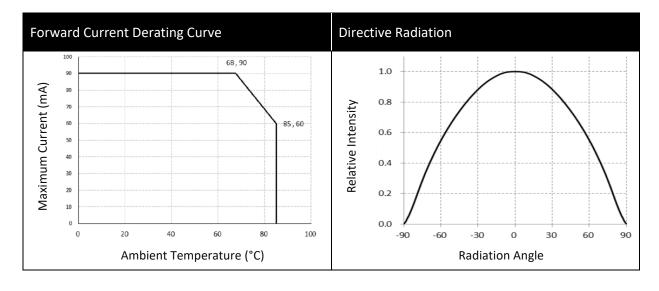
		1	3	3	į	5	-	7
	Х	Υ	Х	Y	Х	Y	Х	Υ
6500K	0.3075	0.3121	0.3035	0.3312	0.3212	0.3489	0.3228	0.3269



ELECTRO-OPTICAL CHARACTERISTICS:



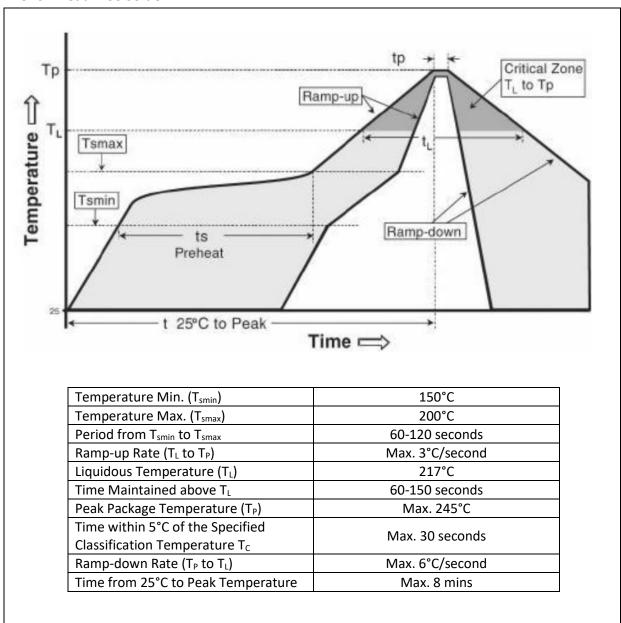






RECOMMENDED SOLDERING PROFILE:

Reflow Lead-free Solder:



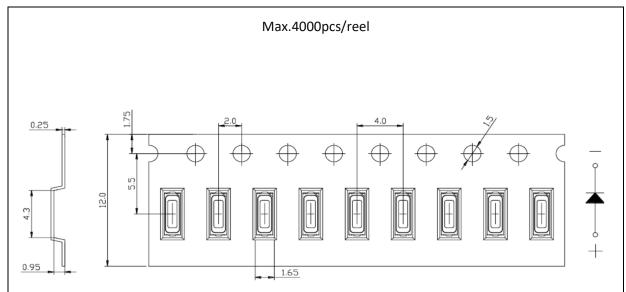
Note:

- 1. Maximum reflow soldering: 2 times.
- 2. Before, during, and after soldering, should not apply stress on the components and PCB board.
- 3. Recommended soldering temperature: 230°C. The maximum soldering temperature should be limited to 245°C for max. 10seconds.

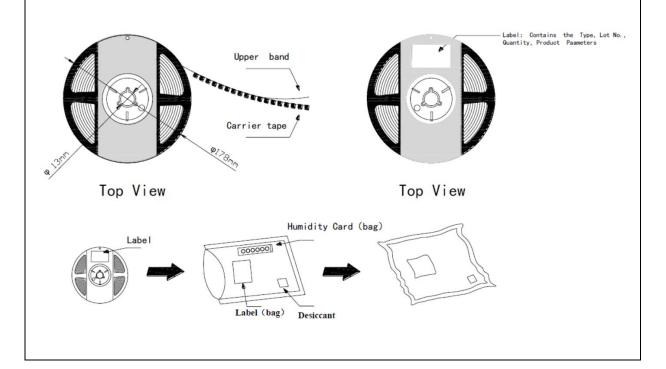


PACKING SPECIFICATION:

Reel Dimension:



- 1. Cumulative Tolerance : Cumulative Tolerance/10 pitches to be ±0.2mm
- 2. Adhesion Strength of Cover Tape Adhesion strength to be 0.1-0.7N when the cover tape is turned off from the carrier tape at the angle of 10° to the carrier tape.





PRECAUTIONS OF USE:

Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 months at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent <10% R.H. and apply baking before use.

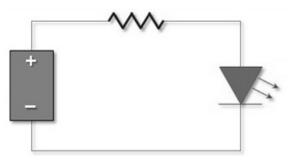
Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

• 60±3°C x 24hrs and <5%RH, taped / reel package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

Testing Circuit:



Must apply resistor(s) for protection (over current proof).

Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



REVISION RECORD:

Version	Date	Summary of Revision
A1.0	01/02/2023	Datasheet set-up.